

Appl. No. 10/712,708  
Amdt. dated July 13, 2007  
Reply to Non-Compliant Amend Notice of June 15, 2007

**PATENT**

made from materials with high thermal conductivity also form a multi-stage heat dissipation module with a heat pipe 16 accommodated therein, further improving the heat dissipation.

**Abstract**

A heat dissipation module includes a fan and a heat sink. The shaft of the fan, made from materials with high thermal conductivity or being a heat pipe, has a first end and an opposite second end. [[,]] with the The first end of the shaft penetrating penetrates a fan hub and connects connecting to a heating element. The heat sink is connected to the second end of the shaft.